

Product/Process Change Notifications



PCN - 16 022

Release Date: April 06 2016

Product Name:	Edge card		
	PCIE Through hole		
Product Manager:	Bonnie Liu		
Subject:	Notification of Change with Immediate Effectivity		
Distribution:	General		
Type of Change:	Documentation Change		
Change Description:	<p>Replace customer soldering application specification of product series 10018783 from customer drawing.</p> <p>Before change: The housing will withstand exposure to 260°C±5°C temperature for 10 seconds in Re-flow application, Refer to GS-14-858 for operating.</p> <p>After change: The housing will withstand exposure to 260°C peak temperature for 10 seconds in wave soldering application, Refer to GS-14-858 for operating.</p> <p>Note: For Re-flow application, we recommend the product series : 10108777 to customers.</p>		
Reason for Change:	Replacing application specification from the customer drawing not matching with the actual product specification.		
Affected Parts:	Part number series 10018783-		
Effective Date of Change:	Oct.10, 2016		
Last Time Buy Date:	NA		
Last Disty Return Date:	NA		
Last Time Shipment Date	NA		
Datasheet Attached?	Yes		
Qual/Test Data Attached?	NA		
Samples Availability Date:	April	6	2016
Available Alternatives?	Select		
Questions?	<i>Contact your local FCI Representative, or Product Manager</i>		
	<i>Bonnie Liu / Product Manager</i>		
	<i>Bonnie Liu / Bonnie.Liu@fci.com +86 769 88669459</i>		

Note:

Customers should contact Product Manager (or their local FCI Representative) directly regarding any concern on the PCN. Lack of any such customer feedback within three weeks of PCN release date will be interpreted as non-objection .